

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of:

Kian Teng Eng, et al.

Docket No.: TI-22944.2

Serial No.: TBD

Examiner: TBD

Filed: 1/19/01

Art Unit: TBD

For: VERTICAL BALL GRID ARRAY INTEGRATED CIRCUIT PACKAGE

PRELIMINARY AMENDMENT

Honorable Assistant Commissioner

of Patents

Washington, D.C. 20231

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Date of Deposit: January 19, 2001

Please amend the above referenced Application as follows:

In the Specification:

Page 1, before line 1, insert --This application claims priority under 35 USC §119(e)(1) of Parent Application number 09/115,565 filed 7/14/1998 and Divisional Application number 09/478,917 filed 1/6/2000.--

In the Claims:

Please cancel claims 26-27.

#1/2/A

Pre-Amendment
D. McInnis
8/4/02

OK to cancel
8/14/02
8/2/02

AI-09547-01
TO: 2495260